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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | MIPS32® M4K™ |
| Core Size | 32-Bit Single-Core |
| Speed | 40MHz |
| Connectivity | I ² C, IrDA, LINbus, PMP, SPI, UART/USART |
| Peripherals | Brown-out Detect/Reset, POR, PWM, WDT |
| Number of I/O | 53 |
| Program Memory Size | 32KB (32K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 8K x 8 |
| Voltage - Supply (Vcc/Vdd) | 2.3V ~ 3.6V |
| Data Converters | A/D 16x10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 105°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 64-TQFP |
| Supplier Device Package | 64-TQFP (10x10) |
| Purchase URL | https://www.e-xfl.com/product-detail/microchip-technology/pic32mx320f032h-40v-pt |

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

| Pin Name | Pin Number ⁽¹⁾ | | | Pin Type | Buffer Type | Description |
|----------|---------------------------|--------------|--------------|----------|-------------|---|
| | 64-pin QFN/TQFP | 100-pin TQFP | 121-pin XBGA | | | |
| CN0 | 48 | 74 | B11 | I | ST | Change notification inputs. Can be software programmed for internal weak pull-ups on all inputs. |
| CN1 | 47 | 73 | C10 | I | ST | |
| CN2 | 16 | 25 | K2 | I | ST | |
| CN3 | 15 | 24 | K1 | I | ST | |
| CN4 | 14 | 23 | J2 | I | ST | |
| CN5 | 13 | 22 | J1 | I | ST | |
| CN6 | 12 | 21 | H2 | I | ST | |
| CN7 | 11 | 20 | H1 | I | ST | |
| CN8 | 4 | 10 | E3 | I | ST | |
| CN9 | 5 | 11 | F4 | I | ST | |
| CN10 | 6 | 12 | F2 | I | ST | |
| CN11 | 8 | 14 | F3 | I | ST | |
| CN12 | 30 | 44 | L8 | I | ST | |
| CN13 | 52 | 81 | C8 | I | ST | |
| CN14 | 53 | 82 | B8 | I | ST | |
| CN15 | 54 | 83 | D7 | I | ST | |
| CN16 | 55 | 84 | C7 | I | ST | |
| CN17 | 31 | 49 | L10 | I | ST | |
| CN18 | 32 | 50 | L11 | I | ST | |
| CN19 | — | 80 | D8 | I | ST | |
| CN20 | — | 47 | L9 | I | ST | |
| CN21 | — | 48 | K9 | I | ST | |
| IC1 | 42 | 68 | E9 | I | ST | Capture inputs 1-5. |
| IC2 | 43 | 69 | E10 | I | ST | |
| IC3 | 44 | 70 | D11 | I | ST | |
| IC4 | 45 | 71 | C11 | I | ST | |
| IC5 | 52 | 79 | A9 | I | ST | |
| OCFA | 17 | 26 | L1 | I | ST | Output Compare Fault A Input. |
| OC1 | 46 | 72 | D9 | O | — | Output Compare output 1. |
| OC2 | 49 | 76 | A11 | O | — | Output Compare output 2 |
| OC3 | 50 | 77 | A10 | O | — | Output Compare output 3. |
| OC4 | 51 | 78 | B9 | O | — | Output Compare output 4. |
| OC5 | 52 | 81 | C8 | O | — | Output Compare output 5. |
| OCFB | 30 | 44 | L8 | I | ST | Output Compare Fault B Input. |
| INT0 | 35,46 | 55,72 | H9,D9 | I | ST | External interrupt 0. |
| INT1 | 42 | 18 | 61 | I | ST | External interrupt 1. |
| INT2 | 43 | 19 | 62 | I | ST | External interrupt 2. |

Legend: CMOS = CMOS compatible input or output
 ST = Schmitt Trigger input with CMOS levels
 TTL = TTL input buffer

Analog = Analog input P = Power
 O = Output I = Input

Note 1: Pin numbers are provided for reference only. See the “Pin Diagrams” section for device pin availability.

PIC32MX3XX/4XX

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

| Pin Name | Pin Number ⁽¹⁾ | | | Pin Type | Buffer Type | Description |
|----------|---------------------------|--------------|--------------|----------|-------------|---|
| | 64-pin QFN/TQFP | 100-pin TQFP | 121-pin XBGA | | | |
| PMD0 | 60 | 93 | A4 | I/O | TTL/ST | Parallel Master Port Data (De-multiplexed Master mode) or Address/Data (Multiplexed Master modes). |
| PMD1 | 61 | 94 | B4 | I/O | TTL/ST | |
| PMD2 | 62 | 98 | B3 | I/O | TTL/ST | |
| PMD3 | 63 | 99 | A2 | I/O | TTL/ST | |
| PMD4 | 64 | 100 | A1 | I/O | TTL/ST | |
| PMD5 | 1 | 3 | D3 | I/O | TTL/ST | |
| PMD6 | 2 | 4 | C1 | I/O | TTL/ST | |
| PMD7 | 3 | 5 | D2 | I/O | TTL/ST | |
| PMD8 | — | 90 | A5 | I/O | TTL/ST | |
| PMD9 | — | 89 | E6 | I/O | TTL/ST | |
| PMD10 | — | 88 | A6 | I/O | TTL/ST | |
| PMD11 | — | 87 | B6 | I/O | TTL/ST | |
| PMD12 | — | 79 | A9 | I/O | TTL/ST | |
| PMD13 | — | 80 | D8 | I/O | TTL/ST | |
| PMD14 | — | 83 | D7 | I/O | TTL/ST | |
| PMD15 | — | 84 | C7 | I/O | TTL/ST | |
| PMRD | 53 | 82 | B8 | O | — | Parallel Master Port Read Strobe. |
| PMWR | 52 | 81 | C8 | O | — | Parallel Master Port Write Strobe. |
| PMALL | 30 | 44 | L8 | O | — | Parallel Master Port Address Latch Enable low-byte (Multiplexed Master modes). |
| PMALH | 29 | 43 | K7 | O | — | Parallel Master Port Address Latch Enable high-byte (Multiplexed Master modes). |
| VBUS | 34 | 54 | H8 | I | Analog | USB Bus Power Monitor. |
| VUSB | 35 | 55 | H9 | P | — | USB Internal Transceiver Supply. If the USB module is <i>not</i> used, this pin must be connected to VDD. |
| VBUSON | 11 | 20 | H1 | O | — | USB Host and OTG Bus Power Control Output. |
| D+ | 37 | 57 | H10 | I/O | Analog | USB D+. |
| D- | 36 | 56 | J11 | I/O | Analog | USB D-. |
| USBID | 33 | 51 | K10 | I | ST | USB OTG ID Detect. |
| ENVREG | 57 | 86 | A7 | I | ST | Enable for On-Chip Voltage Regulator. |
| TRCLK | — | 91 | C5 | O | — | Trace Clock. |
| TRD0 | — | 97 | A3 | O | — | Trace Data Bits 0-3. |
| TRD1 | — | 96 | C3 | O | — | |
| TRD2 | — | 95 | C4 | O | — | |
| TRD3 | — | 92 | B5 | O | — | |
| PGED1 | 16 | 25 | K2 | I/O | ST | Data I/O pin for programming/debugging communication channel 1. |
| PGEC1 | 15 | 24 | K1 | I | ST | Clock input pin for programming/debugging communication channel 1. |

Legend: CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels
TTL = TTL input buffer

Analog = Analog input
O = Output

P = Power
I = Input

Note 1: Pin numbers are provided for reference only. See the “Pin Diagrams” section for device pin availability.

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

| Pin Name | Pin Number ⁽¹⁾ | | | Pin Type | Buffer Type | Description |
|------------|---------------------------|--------------------|--|----------|-------------|--|
| | 64-pin QFN/TQFP | 100-pin TQFP | 121-pin XBGA | | | |
| PGED2 | 18 | 27 | J3 | I/O | ST | Data I/O pin for programming/debugging communication channel 2. |
| PGEC2 | 17 | 26 | L1 | I | ST | Clock input pin for programming/debugging communication channel 2. |
| MCLR | 7 | 13 | F1 | I/P | ST | Master Clear (Reset) input. This pin is an active-low Reset to the device. |
| AVDD | 19 | 30 | J4 | P | P | Positive supply for analog modules. This pin must be connected at all times. |
| AVSS | 20 | 31 | L3 | P | P | Ground reference for analog modules. |
| VDD | 10, 26, 38 | 2, 16, 37, 46, 62 | C2, C9, E5, F8, G5, H4, H6, K8 | P | — | Positive supply for peripheral logic and I/O pins. |
| VCORE/VCAP | 56 | 85 | B7 | P | — | Capacitor for Internal Voltage Regulator. |
| Vss | 9, 25, 41 | 15, 36, 45, 65, 75 | A8, B10, D4, D5, E7, F10, F5, G6, G7, H3 | P | — | Ground reference for logic and I/O pins. |
| VREF+ | 16 | 29 | K3 | I | Analog | Analog voltage reference (high) input. |
| VREF- | 15 | 28 | L2 | I | Analog | Analog voltage reference (low) input. |

Legend: CMOS = CMOS compatible input or output Analog = Analog input P = Power
ST = Schmitt Trigger input with CMOS levels O = Output I = Input
TTL = TTL input buffer

Note 1: Pin numbers are provided for reference only. See the “Pin Diagrams” section for device pin availability.

FIGURE 4-4: MEMORY MAP ON RESET FOR PIC32MX340F128H, PIC32MX340F128L, PIC32MX440F128H AND PIC32MX440F128L DEVICES⁽¹⁾

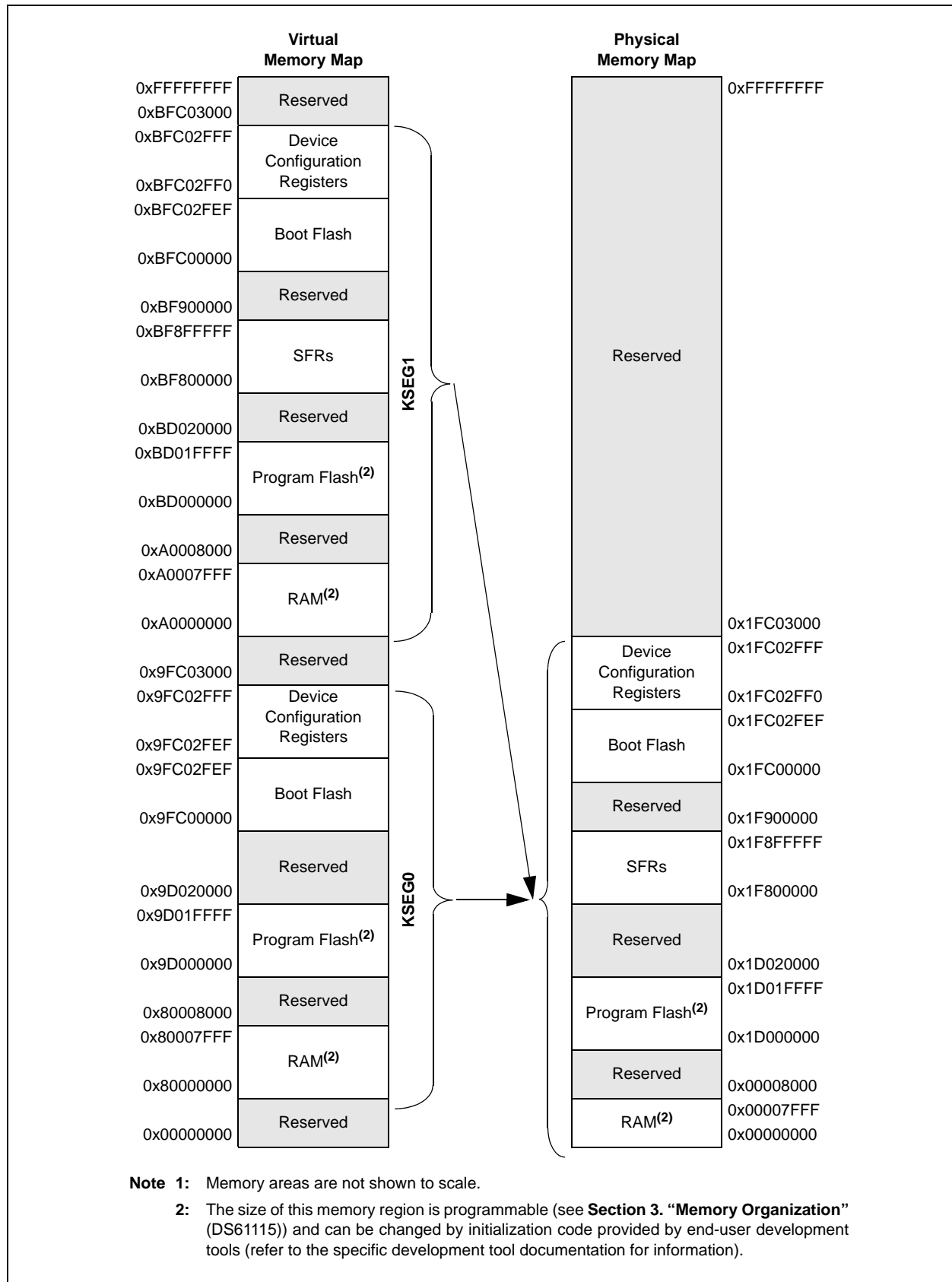


TABLE 4-1: BUS MATRIX REGISTERS MAP

| Virtual Address (BF88_#) | Register Name | Bit Range | Bits | | | | | | | | | | | | | | | | All Resets |
|-----------------------------|-----------------------------|-----------|-----------------|-------|-------|-------|-------|-----------|------|------|------|----------|------|-----------|-----------------|-------------|----------|----------|---------------|
| | | | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 | 16/0 | |
| 2000 | BMX CON ⁽¹⁾ | 31:16 | — | — | — | — | — | BMXCHEDMA | — | — | — | — | — | BMXERRIXI | BMXERRICD | BMXERRDMA | BMXERRDS | BMXERRIS | 001F |
| | | 15:0 | — | — | — | — | — | — | — | — | — | BMXWSDRM | — | — | — | BMXARB<2:0> | | | 0042 |
| 2010 | BMX DKPBA ⁽¹⁾ | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | BMXDKPBA<15:0> | | | | | | | | | | | | | | | | 0000 |
| 2020 | BMX DUDBA ⁽¹⁾ | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | BMXDUDBA<15:0> | | | | | | | | | | | | | | | | 0000 |
| 2030 | BMX DUPBA ⁽¹⁾ | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | BMXDUPBA<15:0> | | | | | | | | | | | | | | | | 0000 |
| 2040 | BMX DRMSZ | 31:16 | BMXDRMSZ<31:0> | | | | | | | | | | | | | | | | xxxx |
| | | 15:0 | | | | | | | | | | | | | | | | | xxxx |
| 2050 | BMX PUPBA ⁽¹⁾ | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | BMXPUPBA<19:16> | | | | 0000 |
| | | 15:0 | BMXPUPBA<15:0> | | | | | | | | | | | | | | | | 0000 |
| 2060 | BMX PFMSZ | 31:16 | BMXPFMSZ<31:0> | | | | | | | | | | | | | | | | xxxx |
| | | 15:0 | | | | | | | | | | | | | | | | | xxxx |
| 2070 | BMX BOOTSZ | 31:16 | BMXBOOTSZ<31:0> | | | | | | | | | | | | | | | | 0000 |
| | | 15:0 | | | | | | | | | | | | | | | | | 3000 |

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This register has corresponding CLR, SET, and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See **Section 12.1.1 “CLR, SET and INV Registers”** for more information.

TABLE 4-17: COMPARATOR REGISTERS MAP⁽¹⁾

| Virtual Address (BF80_#) | Register Name | Bit Range | Bits | | | | | | | | | | | | | | | | All Resets |
|-----------------------------|------------------|-----------|-------|-------|-------|-------|-------|-------|------|------|------------|------|------|------|------|------|----------|-------|------------|
| | | | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 | 16/0 | |
| A000 | CM1CON | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | ON | COE | CPOL | — | — | — | — | COUT | EVPOL<1:0> | | — | CREF | — | — | CCH<1:0> | | 00C3 |
| A010 | CM2CON | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | ON | COE | CPOL | — | — | — | — | COUT | EVPOL<1:0> | | — | CREF | — | — | CCH<1:0> | | 00C3 |
| A060 | CMSTAT | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | SIDL | — | — | — | — | — | — | — | — | — | — | — | C2OUT | C1OUT | 0000 |

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.1.1 “CLR, SET and INV Registers”** for more information.

TABLE 4-18: COMPARATOR VOLTAGE REFERENCE REGISTERS MAP⁽¹⁾

| Virtual Address (BF80_#) | Register Name | Bit Range | Bits | | | | | | | | | | | | | | | | All Resets |
|-----------------------------|------------------|-----------|-------|-------|-------|-------|-------|-------|------|------|------|-------|------|-------|----------|------|------|------|------------|
| | | | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 | 16/0 | |
| 9800 | CVRCON | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | ON | — | — | — | — | — | — | — | — | CVROE | CVRR | CVRSS | CVR<3:0> | | | | 0000 |

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.1.1 “CLR, SET and INV Registers”** for more information.

TABLE 4-31: PORTF REGISTERS MAP FOR PIC32MX320F032H, PIC32MX320F064H, PIC32MX320F128H, PIC32MX340F128H, PIC32MX340F256H AND PIC32MX340F512H DEVICES ONLY⁽¹⁾

| Virtual Address (BF88_#) | Register Name | Bit Range | Bits | | | | | | | | | | | | | | | | All Resets |
|-----------------------------|------------------|-----------|-------|-------|-------|-------|-------|-------|------|------|------|--------|--------|--------|--------|--------|--------|--------|------------|
| | | | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 | 16/0 | |
| 6140 | TRISF | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | — | — | — | — | — | — | — | TRISF6 | TRISF5 | TRISF4 | TRISF3 | TRISF2 | TRISF1 | TRISF0 | 07FF |
| 6150 | PORTF | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | — | — | — | — | — | — | — | RF6 | RF5 | RF4 | RF3 | RF2 | RF1 | RF0 | xxxx |
| 6160 | LATF | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | — | — | — | — | — | — | — | LATF6 | LATF5 | LATF4 | LATF3 | LATF2 | LATF1 | LATF0 | xxxx |
| 6170 | ODCF | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | — | — | — | — | — | — | — | ODCF6 | ODCF5 | ODCF4 | ODCF3 | ODCF2 | ODCF1 | ODCF0 | 0000 |

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.1.1 “CLR, SET and INV Registers”** for more information.

TABLE 4-32: PORTF REGISTERS MAP FOR PIC32MX420F032H, PIC32MX440F128H AND PIC2MX440F256H DEVICES ONLY⁽¹⁾

| Virtual Address (BF88_#) | Register Name | Bit Range | Bits | | | | | | | | | | | | | | | | All Resets |
|-----------------------------|------------------|-----------|-------|-------|-------|-------|-------|-------|------|------|------|------|--------|--------|--------|--------|--------|--------|------------|
| | | | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 | 16/0 | |
| 6140 | TRISF | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | — | — | — | — | — | — | — | — | TRISF5 | TRISF4 | TRISF3 | TRISF2 | TRISF1 | TRISF0 | 03FF |
| 6150 | PORTF | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | — | — | — | — | — | — | — | — | RF5 | RF4 | RF3 | RF2 | RF1 | RF0 | xxxx |
| 6160 | LATF | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | — | — | — | — | — | — | — | — | LATF5 | LATF4 | LATF3 | LATF2 | LATF1 | LATF0 | xxxx |
| 6170 | ODCF | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | — | — | — | — | — | — | — | — | ODCF5 | ODCF4 | ODCF3 | ODCF2 | ODCF1 | ODCF0 | 0000 |

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.1.1 “CLR, SET and INV Registers”** for more information.

TABLE 4-35: CHANGE NOTICE AND PULL-UP REGISTERS MAP FOR PIC32MX320F128L, PIC32MX340F128L, PIC32MX360F256L, PIC32MX360F512L, PIC32MX440F128L, PIC32MX460F256L AND PIC32MX460F512L DEVICES ONLY⁽¹⁾

| Virtual Address (BF88_#) | Register Name | Bit Range | Bits | | | | | | | | | | | | | | | | All Resets |
|-----------------------------|------------------|-----------|---------|---------|---------|---------|---------|---------|--------|--------|--------|--------|---------|---------|---------|---------|---------|---------|------------|
| | | | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 | 16/0 | |
| 61C0 | CNCON | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | ON | — | SIDL | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| 61D0 | CNEN | 31:16 | — | — | — | — | — | — | — | — | — | — | CNEN21 | CNEN20 | CNEN19 | CNEN18 | CNEN17 | CNEN16 | 0000 |
| | | 15:0 | CNEN15 | CNEN14 | CNEN13 | CNEN12 | CNEN11 | CNEN10 | CNEN9 | CNEN8 | CNEN7 | CNEN6 | CNEN5 | CNEN4 | CNEN3 | CNEN2 | CNEN1 | CNEN0 | 0000 |
| 61E0 | CNPUE | 31:16 | — | — | — | — | — | — | — | — | — | — | CNPUE21 | CNPUE20 | CNPUE19 | CNPUE18 | CNPUE17 | CNPUE16 | 0000 |
| | | 15:0 | CNPUE15 | CNPUE14 | CNPUE13 | CNPUE12 | CNPUE11 | CNPUE10 | CNPUE9 | CNPUE8 | CNPUE7 | CNPUE6 | CNPUE5 | CNPUE4 | CNPUE3 | CNPUE2 | CNPUE1 | CNPUE0 | 0000 |

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.1.1 “CLR, SET and INV Registers”** for more information.

TABLE 4-36: CHANGE NOTICE AND PULL-UP REGISTERS MAP FOR PIC32MX320F032H, PIC32MX320F064H, PIC32MX320F128H, PIC32MX340F128H, PIC32MX340F256H, PIC32MX340F512H, PIC32MX420F032H, PIC32MX440F128H, PIC32MX440F256H AND PIC32MX440F512H DEVICES ONLY⁽¹⁾

| Virtual Address (BF88_#) | Register Name | Bit Range | Bits | | | | | | | | | | | | | | | | All Resets |
|-----------------------------|------------------|-----------|---------|---------|---------|---------|---------|---------|--------|--------|--------|--------|--------|--------|--------|---------|---------|---------|------------|
| | | | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 | 16/0 | |
| 61C0 | CNCON | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | ON | — | SIDL | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| 61D0 | CNEN | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | CNEN18 | CNEN17 | CNEN16 | 0000 |
| | | 15:0 | CNEN15 | CNEN14 | CNEN13 | CNEN12 | CNEN11 | CNEN10 | CNEN9 | CNEN8 | CNEN7 | CNEN6 | CNEN5 | CNEN4 | CNEN3 | CNEN2 | CNEN1 | CNEN0 | 0000 |
| 61E0 | CNPUE | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | CNPUE18 | CNPUE17 | CNPUE16 | 0000 |
| | | 15:0 | CNPUE15 | CNPUE14 | CNPUE13 | CNPUE12 | CNPUE11 | CNPUE10 | CNPUE9 | CNPUE8 | CNPUE7 | CNPUE6 | CNPUE5 | CNPUE4 | CNPUE3 | CNPUE2 | CNPUE1 | CNPUE0 | 0000 |

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.1.1 “CLR, SET and INV Registers”** for more information.

TABLE 4-37: PARALLEL MASTER PORT REGISTERS MAP⁽¹⁾

| Virtual Address (BF80_#) | Register Name | Bit Range | Bits | | | | | | | | | | | | | | | | All Resets |
|-----------------------------|------------------|-----------|---------------|-----------|------------|-------------|-------|--------|-----------|--------|------------|------|------------|------|------|------------|------|------|------------|
| | | | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 | 16/0 | |
| 7000 | PMCON | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | ON | — | SIDL | ADRMUX<1:0> | | PMPCTL | PTWREN | PTRDEN | CSF<1:0> | | ALP | CS2P | CS1P | — | WRSP | RDSP | 0000 |
| 7010 | PMMODE | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | BUSY | IRQM<1:0> | | INCM<1:0> | | MODE16 | MODE<1:0> | | WAITB<1:0> | | WAITM<3:0> | | | WAITE<1:0> | | | 0000 |
| 7020 | PMADDR | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | CS2EN/A15 | CS1EN/A14 | ADDR<13:0> | | | | | | | | | | | | | | |
| 7030 | PMDOUT | 31:16 | DATAOUT<31:0> | | | | | | | | | | | | | | | | 0000 |
| | | 15:0 | | | | | | | | | | | | | | | | | 0000 |
| 7040 | PMDIN | 31:16 | DATAIN<31:0> | | | | | | | | | | | | | | | | 0000 |
| | | 15:0 | | | | | | | | | | | | | | | | | 0000 |
| 7050 | PMAEN | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | PTEN<15:0> | | | | | | | | | | | | | | | | 0000 |
| 7060 | PMSTAT | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | IBF | IBOV | — | — | IB3F | IB2F | IB1F | IB0F | OBE | OBUF | — | — | OB3E | OB2E | OB1E | OB0E | 008F |

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.1.1 “CLR, SET and INV Registers”** for more information.

TABLE 4-38: PROGRAMMING AND DIAGNOSTICS REGISTERS MAP

| Virtual Address (BF80_#) | Register Name | Bit Range | Bits | | | | | | | | | | | | | | | | All Resets |
|-----------------------------|------------------|-----------|-------|-------|-------|-------|-------|-------|------|------|------|------|------|------|--------|-------|------|------|------------|
| | | | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 | 16/0 | |
| F200 | DDPCON | 31:16 | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | 0000 |
| | | 15:0 | — | — | — | — | — | — | — | — | — | — | — | — | JTAGEN | TROEN | — | — | 0008 |

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

13.0 TIMER1

Note 1: This data sheet summarizes the features of the PIC32MX3XX/4XX family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 14. “Timers”** (DS61105) of the *“PIC32 Family Reference Manual”*, which is available from the Microchip web site (www.microchip.com/PIC32).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

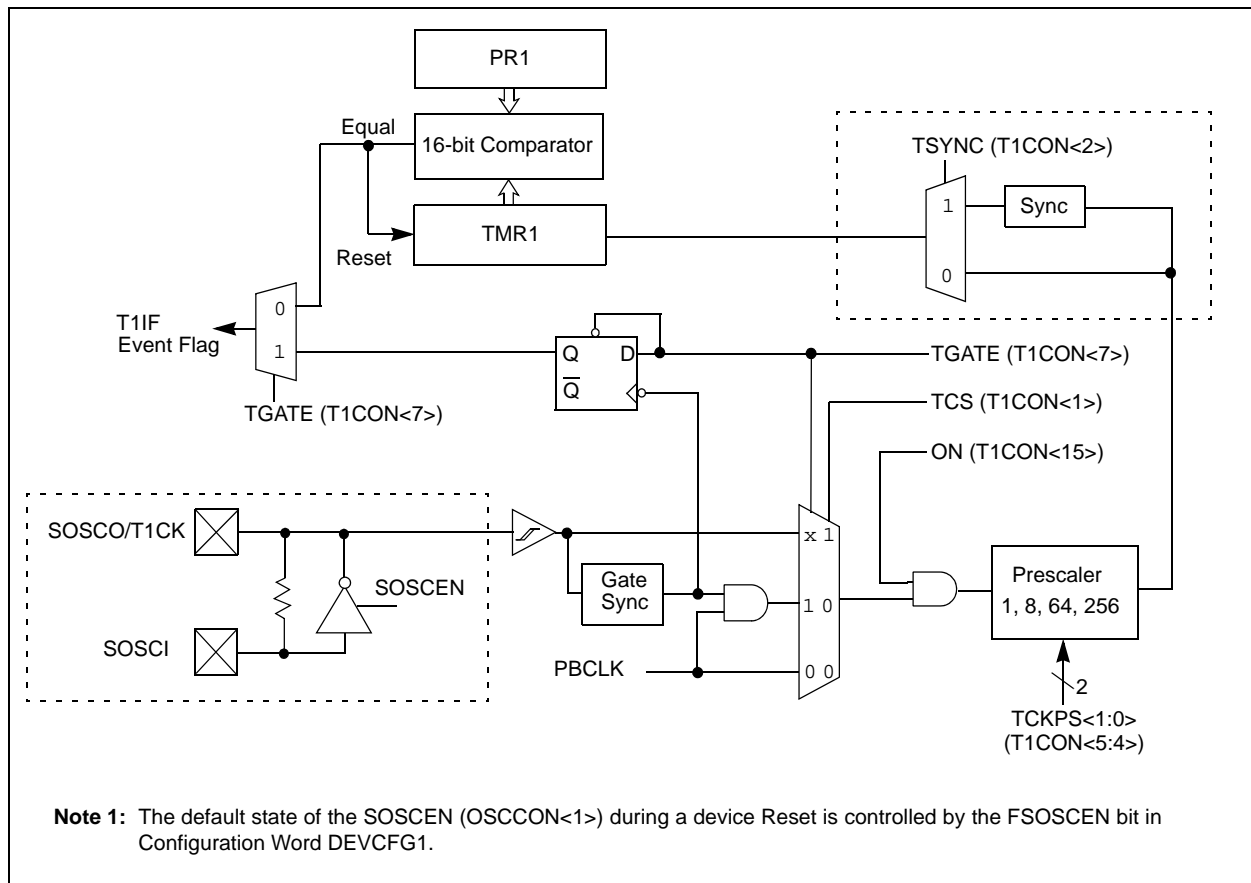
This family of PIC32MX devices features one synchronous/asynchronous 16-bit timer that can operate as a free-running interval timer for various timing applications and counting external events. This timer can also be used with the Secondary Oscillator (Sosc) for real-time clock applications. The following modes are supported:

- Synchronous Internal Timer
- Synchronous Internal Gated Timer
- Synchronous External Timer
- Asynchronous External Timer

13.1 Additional Supported Features

- Selectable clock prescaler
- Timer operation during CPU Idle and Sleep mode
- Fast bit manipulation using CLR, SET and INV registers
- Asynchronous mode can be used with the Sosc to function as a Real-Time Clock (RTC)

FIGURE 13-1: TIMER1 BLOCK DIAGRAM⁽¹⁾



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NOTES:

22.0 10-BIT ANALOG-TO-DIGITAL CONVERTER (ADC)

Note 1: This data sheet summarizes the features of the PIC32MX3XX/4XX family of devices. It is not intended to be a comprehensive reference source. Refer to **Section 17. “10-bit Analog-to-Digital Converter (ADC)”** (DS61104) of the “PIC32 Family Reference Manual”, which is available from the Microchip web site (www.microchip.com/PIC32).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The PIC32MX3XX/4XX 10-bit Analog-to-Digital Converter (ADC) includes the following features:

- Successive Approximation Register (SAR) conversion
- Up to 1000 kilo samples per second (ksps) conversion speed
- Up to 16 analog input pins
- External voltage reference input pins
- One unipolar, differential Sample-and-Hold Amplifier (SHA)

- Automatic Channel Scan mode
- Selectable conversion trigger source
- 16-word conversion result buffer
- Selectable Buffer Fill modes
- Eight conversion result format options
- Operation during CPU Sleep and Idle modes

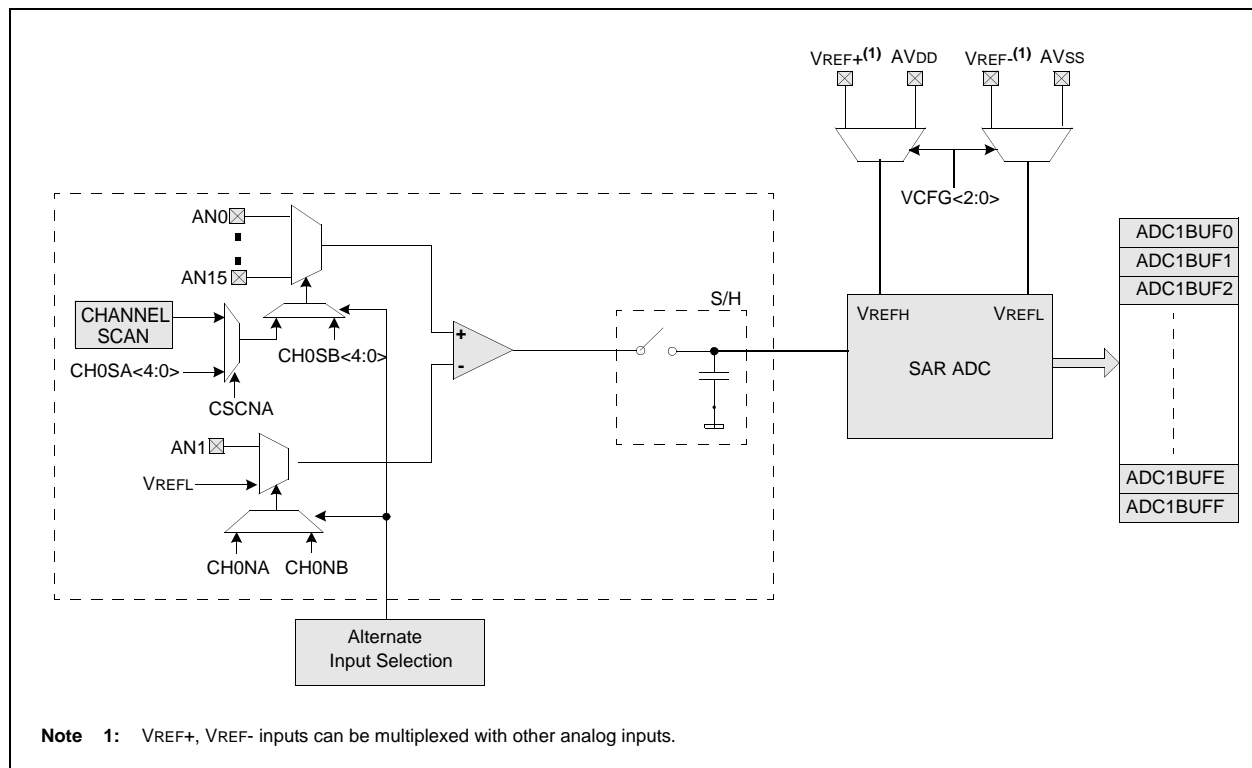
A block diagram of the 10-bit ADC is illustrated in Figure 22-1. The 10-bit ADC has 16 analog input pins, designated AN0-AN15. In addition, there are two analog input pins for external voltage reference connections. These voltage reference inputs may be shared with other analog input pins and may be common to other analog module references.

The analog inputs are connected through two multiplexers (MUXs) to one SHA. The analog input MUXs can be switched between two sets of analog inputs between conversions. Unipolar differential conversions are possible on all channels, other than the pin used as the reference, using a reference input pin (see Figure 22-1).

The Analog Input Scan mode sequentially converts user-specified channels. A control register specifies which analog input channels will be included in the scanning sequence.

The 10-bit ADC is connected to a 16-word result buffer. Each 10-bit result is converted to one of eight, 32-bit output formats when it is read from the result buffer.

FIGURE 22-1: ADC1 MODULE BLOCK DIAGRAM



PIC32MX3XX/4XX

The processor will exit, or 'wake-up', from Sleep on one of the following events:

- On any interrupt from an enabled source that is operating in Sleep. The interrupt priority must be greater than the current CPU priority.
- On any form of device Reset.
- On a WDT time-out. See **Section 26.2 “Watchdog Timer (WDT)”**.

If the interrupt priority is lower than or equal to current priority, the CPU will remain halted, but the PBCLK will start running and the device will enter into Idle mode.

Note: There is no FRZ mode for this module.

25.3.2 IDLE MODE

In the Idle mode, the CPU is halted but the System clock (SYSCLK) source is still enabled. This allows peripherals to continue operation when the CPU is halted. Peripherals can be individually configured to halt when entering Idle by setting their respective SIDL bit. Latency when exiting Idle mode is very low due to the CPU oscillator source remaining active.

Note: Changing the PBCLK divider ratio requires recalculation of peripheral timing. For example, assume the UART is configured for 9600 baud with a PB clock ratio of 1:1 and a Posc of 8 MHz. When the PB clock divisor of 1:2 is used, the input frequency to the baud clock is cut in half; therefore, the baud rate is reduced to 1/2 its former value. Due to numeric truncation in calculations (such as the baud rate divisor), the actual baud rate may be a tiny percentage different than expected. For this reason, any timing calculation required for a peripheral should be performed with the new PB clock frequency instead of scaling the previous value based on a change in PB divisor ratio.

Oscillator start-up and PLL lock delays are applied when switching to a clock source that was disabled and that uses a crystal and/or the PLL. For example, assume the clock source is switched from Posc to LPRC just prior to entering Sleep in order to save power. No oscillator start-up delay would be applied when exiting Idle. However, when switching back to Posc, the appropriate PLL and/or oscillator startup/lock delays would be applied.

The device enters Idle mode when the SLPEN (OSCCON<4>) bit is clear and a WAIT instruction is executed.

The processor will wake or exit from Idle mode on the following events:

- On any interrupt event for which the interrupt source is enabled. The priority of the interrupt event must be greater than the current priority of CPU. If the priority of the interrupt event is lower than or equal to current priority of CPU, the CPU will remain halted and the device will remain in Idle mode.
- On any source of device Reset.
- On a WDT time-out interrupt. See **Section 26.2 “Watchdog Timer (WDT)”**.

25.3.3 PERIPHERAL BUS SCALING METHOD

Most of the peripherals on the device are clocked using the PBCLK. The peripheral bus can be scaled relative to the SYSCLK to minimize the dynamic power consumed by the peripherals. The PBCLK divisor is controlled by PBDIV<1:0> (OSCCON<20:19>), allowing SYSCLK-to-PBCLK ratios of 1:1, 1:2, 1:4 and 1:8. All peripherals using PBCLK are affected when the divisor is changed. Peripherals such as USB, Interrupt Controller, DMA, Bus Matrix and Prefetch Cache are clocked directly from SYSCLK, as a result, they are not affected by PBCLK divisor changes

Changing the PBCLK divisor affects:

- The CPU to peripheral access latency. The CPU has to wait for next PBCLK edge for a read to complete. In 1:8 mode this results in a latency of one to seven SYSCLKs.
- The power consumption of the peripherals. Power consumption is directly proportional to the frequency at which the peripherals are clocked. The greater the divisor, the lower the power consumed by the peripherals.

To minimize dynamic power the PB divisor should be chosen to run the peripherals at the lowest frequency that provides acceptable system performance. When selecting a PBCLK divider, peripheral clock requirements such as baud rate accuracy should be taken into account. For example, the UART peripheral may not be able to achieve all baud rate values at some PBCLK divider depending on the SYSCLK value.

28.2 MPLAB C Compilers for Various Device Families

The MPLAB C Compiler code development systems are complete ANSI C compilers for Microchip's PIC18, PIC24 and PIC32 families of microcontrollers and the dsPIC30 and dsPIC33 families of digital signal controllers. These compilers provide powerful integration capabilities, superior code optimization and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

28.3 HI-TECH C for Various Device Families

The HI-TECH C Compiler code development systems are complete ANSI C compilers for Microchip's PIC family of microcontrollers and the dsPIC family of digital signal controllers. These compilers provide powerful integration capabilities, omniscient code generation and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

The compilers include a macro assembler, linker, pre-processor, and one-step driver, and can run on multiple platforms.

28.4 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

28.5 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler and the MPLAB C18 C Compiler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/librarian features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

28.6 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC devices. MPLAB C Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command line interface
- Rich directive set
- Flexible macro language
- MPLAB IDE compatibility

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FIGURE 29-9: OC/PWM MODULE TIMING CHARACTERISTICS

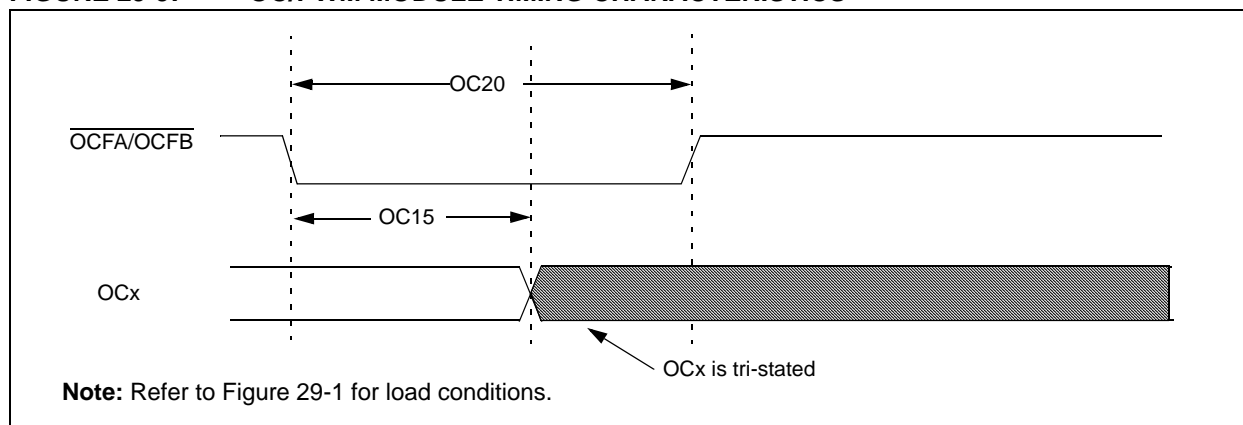


TABLE 29-27: SIMPLE OC/PWM MODE TIMING REQUIREMENTS

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +105^{\circ}\text{C}$ for V-Temp | | | | |
|--------------------|------------------|--------------------------------|---|------------------------|-----|-------|------------|
| Param No. | Symbol | Characteristics ⁽¹⁾ | Min | Typical ⁽²⁾ | Max | Units | Conditions |
| OC15 | T _{FD} | Fault Input to PWM I/O Change | — | — | 25 | ns | — |
| OC20 | T _{FLT} | Fault Input Pulse Width | 50 | — | — | ns | — |

Note 1: These parameters are characterized, but not tested in manufacturing.

Note 2: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

FIGURE 29-10: SPIx MODULE MASTER MODE (CKE = 0) TIMING CHARACTERISTICS

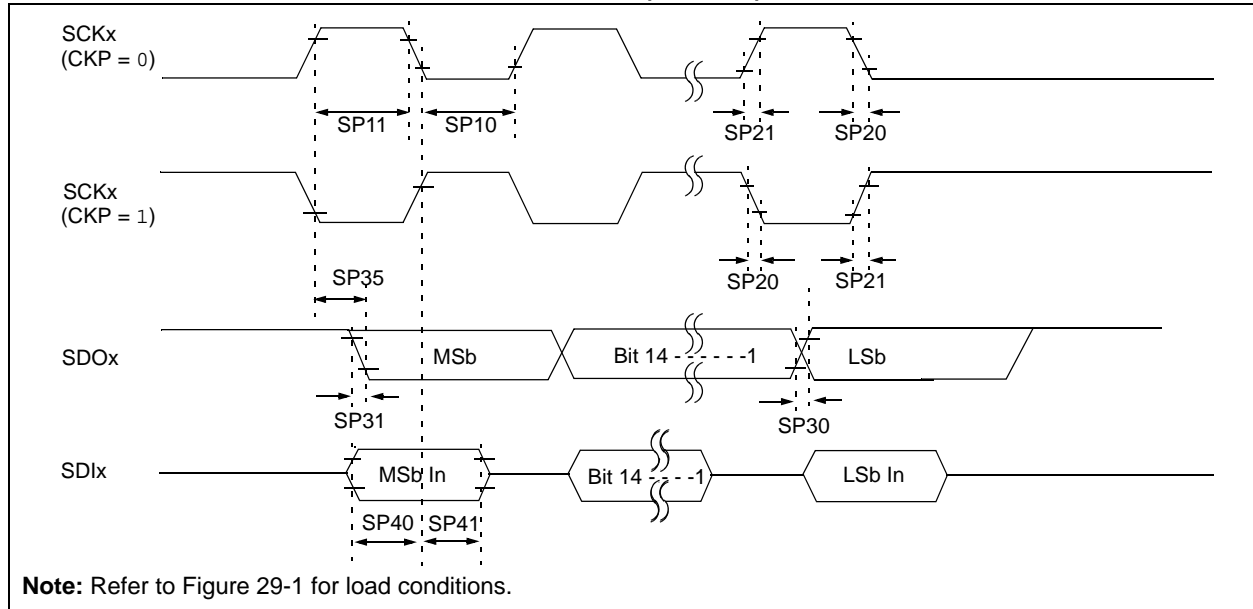


TABLE 29-28: SPIx MASTER MODE (CKE = 0) TIMING REQUIREMENTS

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +105°C for V-Temp | | | | |
|--------------------|-----------------------|---|---|------------------------|------|-------|--------------------|
| Param. No. | Symbol | Characteristics ⁽¹⁾ | Min. | Typical ⁽²⁾ | Max. | Units | Conditions |
| SP10 | TsCL | SCKx Output Low Time ⁽³⁾ | Tsck/2 | — | — | ns | — |
| SP11 | TsCH | SCKx Output High Time ⁽³⁾ | Tsck/2 | — | — | ns | — |
| SP20 | TscF | SCKx Output Fall Time ⁽⁴⁾ | — | — | — | ns | See parameter DO32 |
| SP21 | TscR | SCKx Output Rise Time ⁽⁴⁾ | — | — | — | ns | See parameter DO31 |
| SP30 | TdOF | SDOx Data Output Fall Time ⁽⁴⁾ | — | — | — | ns | See parameter DO32 |
| SP31 | TdOR | SDOx Data Output Rise Time ⁽⁴⁾ | — | — | — | ns | See parameter DO31 |
| SP35 | Tsch2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | — | 15 | ns | VDD > 2.7V |
| | | | — | — | 20 | ns | VDD < 2.7V |
| SP40 | TdIV2sch, TdIV2scl | Setup Time of SDIx Data Input to SCKx Edge | 10 | — | — | ns | — |
| SP41 | Tsch2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 10 | — | — | ns | — |

Note 1: These parameters are characterized, but not tested in manufacturing.

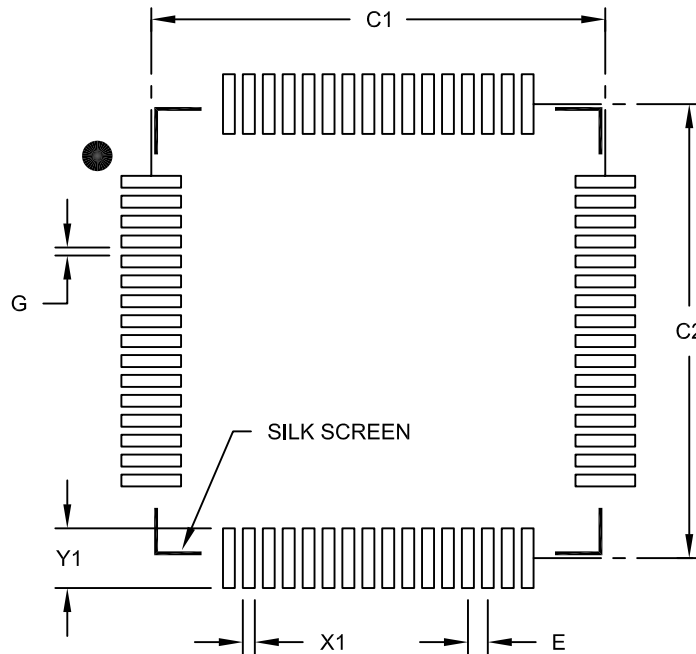
2: Data in “Typical” column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: The minimum clock period for SCKx is 40 ns. Therefore, the clock generated in Master mode must not violate this specification.

4: Assumes 50 pF load on all SPIx pins.

64-Lead Plastic Thin Quad Flatpack (PT) 10x10x1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|--------------------------|----|-------------|-------|------|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | 0.50 BSC | | |
| Contact Pad Spacing | C1 | | 11.40 | |
| Contact Pad Spacing | C2 | | 11.40 | |
| Contact Pad Width (X64) | X1 | | | 0.30 |
| Contact Pad Length (X64) | Y1 | | | 1.50 |
| Distance Between Pads | G | 0.20 | | |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2085B

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NOTES:

Revision H (May 2011)

The revision includes the following global update:

- All references to VDDCORE/VCAP have been changed to: VCORE/VCAP
- Added references to the new V-Temp temperature range: -40°C to +105°C

This revision also includes minor typographical and formatting changes throughout the data sheet text. Major updates are referenced by their respective section in the following table.

TABLE A-3: MAJOR SECTION UPDATES

| Section Name | Update Description |
|--|---|
| Section 1.0 “Device Overview” | Updated the VBUS description in Table 1-1: “Pinout I/O Descriptions” . |
| Section 4.0 “Memory Organization” | Added Note 2 and changed the RIPL<2:0> bits to SRIPL<2:0> in the Interrupt Register Map tables (see Table 4-2 through Table 4-6). Added Note 2 to the Timer1-5 Register Map (see Table 4-7). Updated the All Resets value for I2C1CON<15:0> and I2C2CON<15:0> in the I2C1 and I2C2 Register Map (see Table 4-10). Updated the All Resets value for SPI1STAT<15:0> and SPI2STAT<15:0> in the SPI1 and SPI2 Register Map (see Table 4-12). Updated the All Resets value for CM1CON<15:0> and CM2CON<15:0> in the Comparator Register Map (see Table 4-17). Renamed the RCDIV<2:0> bits to FRCDIV<2:0> and the LOCK bit to SLOCK in the OSCCON register, and added Note 3 and the SYSKEY register to the System Control Registers Map (see Table 4-20). Updated the All Resets value for the PMSTAT register in the Parallel Master Port Register Map (see Table 4-37). Updated the All Resets value for CHECON<15:0> and CHETAG<15:0> in the Prefetch Register Map (see Table 4-39). Renamed FUPLEN, FUPLLDIV, and FPLLMULT in the DEVCFG2 register to: UPLEN, UPLLDIV, and FPLLMUL, respectively in the Device Configuration Word Summary (see Table 4-41). Added Notes 1 through 4 to the USB Register Map (see Table 4-43). |
| Section 5.0 “Flash Program Memory” | Added a note on Flash LVD Delay and Example 5-1. |
| Section 8.0 “Oscillator Configuration” | Updated the PIC32MX3XX/4XX Family Clock Diagram (see Figure 8-1). |
| Section 11.0 “USB On-The-Go (OTG)” | Updated the PIC32MX3XX/4XX Family USB Interface Diagram (see Figure 11-1). |
| Section 16.0 “Output Compare” | Updated the Output Compare Module Block Diagram (see Figure 16-1). |
| Section 22.0 “10-bit Analog-to-Digital Converter (ADC)” | Updated the ADC Conversion Clock Period Block Diagram (see Figure 22-2). |
| Section 26.0 “Special Features” | Renamed FUPLEN, FUPLLDIV, and FPLLMULT in the DEVCFG2 register to: UPLEN, UPLLDIV, and FPLLMUL, respectively (see Register 26-3). |

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TABLE A-3: MAJOR SECTION UPDATES (CONTINUED)

| Section Name | Update Description |
|--|---|
| Section 29.0 “Electrical Characteristics” | <p>Added the new V-Temp temperature range (-40°C to +105°C) to the heading of all specification tables.</p> <p>Updated the Ambient temperature under bias, updated the Voltage on any 5V tolerant pin with respect to V_{SS} when V_{DD} < 2.3V, and added Voltage on V_{BUS} with respect to V_{SS} in Absolute Maximum Ratings.</p> <p>Added the characteristic, DC5a to Operating MIPS vs. Voltage (see Table 29-1).</p> <p>Updated or added the following parameters to the Operating Current (I_{DD}) DC Characteristics: DC20, DC23, DC24c, DC25d, DC26c (see Table 29-5).</p> <p>Added the following parameters to the Idle Current (I_{IDLE}) DC Characteristics: DC30c, DC31c, DC32c, DS33c, DC34c, DC35c, and DC36c (see Table 29-6).</p> <p>Added the following parameters to the Power-down Current (I_{PD}) DC Characteristics: DC40g, DC40h, DC40i, DC41g, DC41h, DC42g, DC42h, DC42i, DC43h, and DC43i (see Table 29-7).</p> <p>Added the Brown-out Reset (BOR) Electrical Characteristics (see Table 29-10).</p> <p>Removed all Conditions from the Program Memory DC Characteristics (see Table 29-11).</p> <p>Removed the AC Characteristics voltage reference table (Table 29-15).</p> <p>Added Note 2 to the PLL Clock Timing Specifications (see Table 29-18).</p> <p>Updated the OC/PWM Module Timing Characteristics (see Figure 29-9).</p> <p>Added parameter IM51 and Note 3 to the I2Cx Bus Data Timing Requirements (Master Mode) (see Table 29-32).</p> <p>Added parameter numbers (AD13, AD14, and AD15) to the ADC Module Specifications (see Table 29-34).</p> <p>Updated the 10-bit ADC Conversion Rate Parameters (see Table 29-35).</p> <p>Updated parameter AD57 (TSAMP) in the Analog-to-Digital Conversion Timing Requirements (see Table 29-36).</p> <p>Updated the Conditions for parameters USB313, USB318, and USB319 in the OTG Electrical Specifications (see Table 29-40).</p> |
| Section 30.0 “Packaging Information” | Updated the 64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN] packing diagram. |
| Product Identification System | Added the new V-Temp (V) temperature information. |